

WP937MD/2YGW

DESCRIPTIONS

T-1 (3mm) Bi-Level Circuit Board Indicator



PACKAGE DIMENSIONS

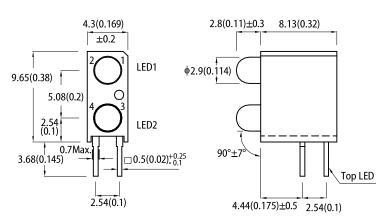
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode
- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

FEATURES

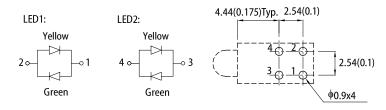
- · Pre-trimmed leads for pc mounting
- Black case enhances contrast ratio
- · High reliability life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- RoHS compliant

APPLICATIONS

- Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- Commercial and residential architectural lighting



Recommended PCB Layout



1. All dimensions are in millimeters (inches).

Tolerance is ±0.25(0.01") unless otherwise noted.
 Lead spacing is measured where the leads emerge from the package

4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA [2]		Viewing Angle ^[1]
			Min.	Тур.	201/2
WP937MD/2YGW	Yellow (GaAsP/GaP)	White Diffused	4	8	60°
	Green (GaP)		6	14	00

Notes

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 Luminous intensity / luminous flux: +/-15%.
- Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Falametei			Тур.	Max.	
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Yellow Green	590 565	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Yellow Green	588 568	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Yellow Green	35 30	-	nm
Capacitance	С	Yellow Green	20 15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Yellow Green	2.1 2.2	2.5 2.5	V

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Va	11	
Parameter		Yellow	Green	Unit
Power Dissipation	P _D	75	62.5	mW
Junction Temperature	Tj	110 110		°C
Operating Temperature	T _{op}	-40 to +85		°C
Storage Temperature	T _{stg}	-40 to +85		°C
DC Forward Current	I _F	30	25	mA
Peak Forward Current	I _{FM} ^[1]	140	140	mA
Electrostatic Discharge Threshold (HBM)	-	8000	8000	V
Lead Solder Temperature ^[2]		260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds			

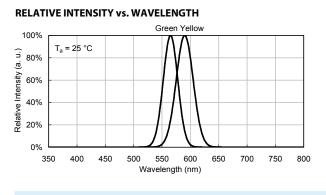
Notes:

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base. 3. 5mm below package base. 4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

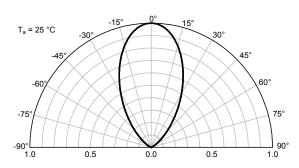
Kingbright

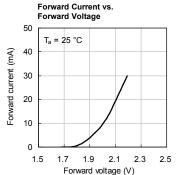
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TECHNICAL DATA



SPATIAL DISTRIBUTION





YELLOW

50

40

30

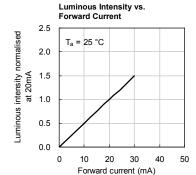
20

10

0

-40

Permissible forward current (mA)



Luminous Intensity vs.

20

Forward current (mA)

30 40

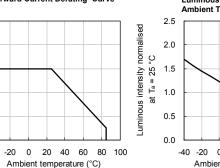
Forward Current

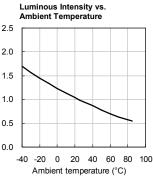
T_a = 25 °C

0

10

Forward Current Derating Curve

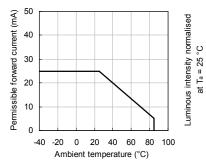




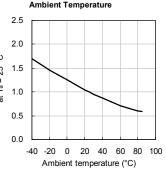
Forward Current vs. Forward Voltage 50 Luminous intensity normalised at T_a = 25 °C 40 Forward current (mA) 30 20 10 0 2.3 2.5 2.7 1.7 1.9 2.1 Forward voltage (V)

GREEN

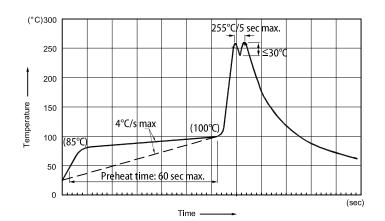
Forward Current Derating Curve



Luminous Intensity vs.



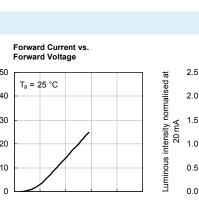
RECOMMENDED WAVE SOLDERING PROFILE



Notes:

- 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C

- Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
 Do not apply stress to the epoxy resin while the temperature is above 85°C.
 Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended.
 6. No more than one wave soldering pass

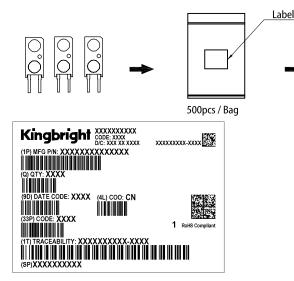


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Kingbright

WP937MD/2YGW

PACKING & LABEL SPECIFICATIONS







PRECAUTIONS

Storage Conditions

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- 2. LEDs should be stored with temperature \leq 30°C and relative humidity < 60%.
- 3. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

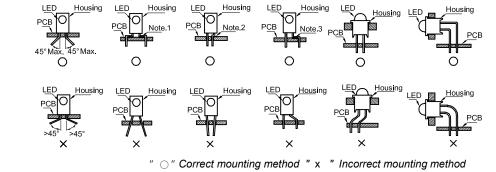
LED Mounting Method

 The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure

the lead pitch matches the hole pitch.

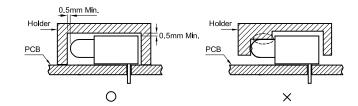
Refer to the figure below for proper lead forming procedures.

Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.



Lead Forming Procedures

- 1. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.
- 2. The tip of the soldering iron should never touch the lens epoxy.
- 3. Through-hole LEDs are incompatible with reflow soldering.
- 4. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



PRECAUTIONARY NOTES

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
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